

RF4P060BG

Nch 100V 6.0A Power MOSFET

V _{DSS}	100V
R _{DS(on)} (Max.)	53mΩ
I _D	±6.0A
P _D	2.0W

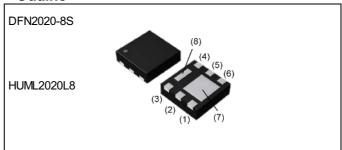
● Features

- 1) Low on resistance
- 2) High Power small mold Package (HUML2020L8)
- 3) Pb-free plating; RoHS compliant
- 4) Halogen Free

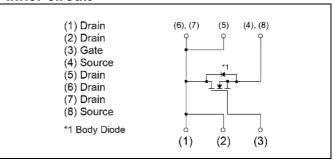
Application

Switching

Outline



●Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Quantity (pcs)	3000
	Taping code	TCR
	Marking	KF

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V_{DSS}	100	V
Continuous drain current	I _D	±6.0	Α
Pulsed drain current	I _{DP} *1	±24	Α
Gate - Source voltage	V_{GSS}	±20	V
Avalanche current, single pulse	I _{AS} *2	6.0	Α
Avalanche energy, single pulse	E _{AS} *2	3.5	mJ
Power dissipation	P _D *3	2.0	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Parameter	Cymphol	Values			Lloit
raidilletei	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - ambient	R _{thJA} *3	-	-	62.5	°C/W

● Electrical characteristics (T_a = 25°C)

Davamatav	Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	100	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_i} I_D = 1 \text{mA}$ referenced to 25°C		67	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V	-	-	1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	1	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}V$, $I_D = 1mA$	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\DeltaV_{GS(th)}}{\DeltaT_j}$	I _D = 1mA referenced to 25°C	-	-4.0	-	mV/°C
Static drain - source	D *4	V _{GS} = 10V, I _D = 6.0A	-	41	53	0
on - state resistance	R _{DS(on)} *4	V _{GS} = 4.5V, I _D = 6.0A	-	52	78	mΩ
Gate resistance	R_G	-	-	2.2	-	Ω
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 5V, I _D = 6A	3.7	-	-	S

^{*1} Pw \leq 10µs, Duty cycle \leq 1%

^{*2} L \simeq 0.1mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_i = 25 $^{\circ}$ C Fig.3-1,3-2

^{*3} Mounted on a Cu board (40×40×0.8mm)

^{*4} Pulsed

● Electrical characteristics (T_a = 25°C)

Daramatar	Cymahal	Conditions	Values			Unit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	UIIIL	
Input capacitance	C _{iss}	V _{GS} = 0V	-	305	-		
Output capacitance	C _{oss}	V _{DS} = 50V	-	80	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	6	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 50V, V_{GS} = 10V$	1	7.5	-		
Rise time	t _r *4	I _D = 3.0A	1	11.0	1	no	
Turn - off delay time	$t_{d(off)}^{*4}$	R _L ~ 16.6Ω	-	21.0	_	ns	
Fall time	t _f *4	$R_G = 10\Omega$	-	6.0	-		

• Gate charge characteristics $(T_a = 25^{\circ}C)$

Doromotor	Cymahal	Conditions		Values			l limit
Parameter	Symbol Cond		ons	Min.	Тур.	Max.	Unit
Total gate charge	O *4		V _{GS} = 10V	-	6.7	-	
Total gate charge	Q _g *4	V _{DD} ≃ 50V		-	3.3	-	~C
Gate - Source charge	Q _{gs} *4	I _D = 6.0A	V _{GS} = 4.5V	-	1.0	-	nC
Gate - Drain charge	Q _{gd} *4			-	1.2	-	

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Darameter	Cumbal	Conditions	Values			Unit
Parameter	Parameter Symbol Conditions		Min.	Тур.	Max.	Offic
Continuous forward current	I _S	T = 25°C	-	-	1.67	Α
Pulse forward current	I _{SP} *1	T _a = 25°C	-	-	24	Α
Forward voltage	V _{SD} *4	V _{GS} = 0V, I _S = 1.67A	-	-	1.2	V
Reverse recovery time	t _{rr} *4	I _S = 6.0A, V _{GS} =0V	-	39	-	ns
Reverse recovery charge	Q _{rr} *4	di/dt = 100A/μs	-	55	-	nC

Fig.1 Power Dissipation Derating Curve

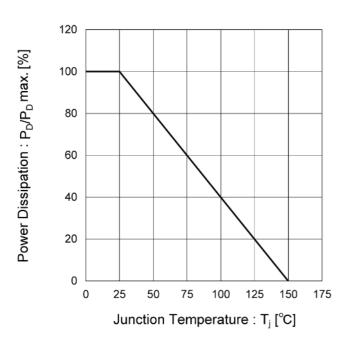
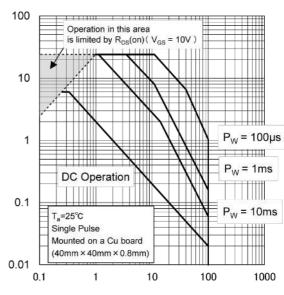


Fig.2 Maximum Safe Operating Area



Drain Current : I_D [A]

Drain - Source Voltage: VDS [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

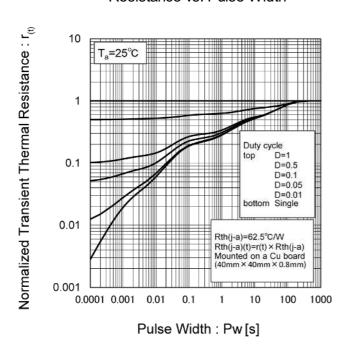
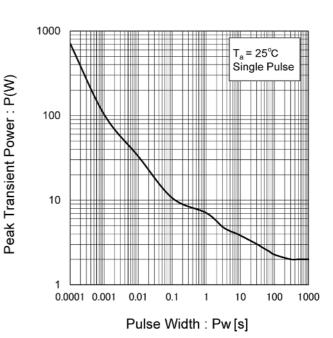


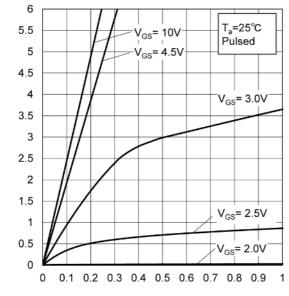
Fig.4 Single Pulse Maximum Power Dissipation



Drain Current: Ip [A]

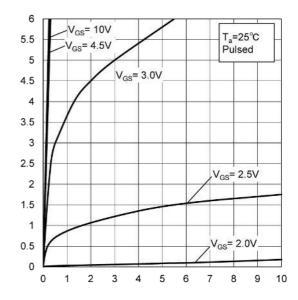
• Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)



Drain - Source Voltage : V_{DS} [V]

Fig.6 Typical Output Characteristics(II)



Drain Current: Ip [A]

Drain - Source Voltage : V_{DS} [V]

Fig.7 Breakdown Voltage vs.

Junction Temperature

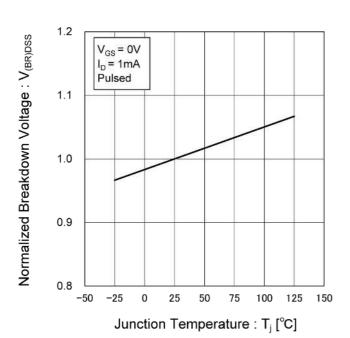


Fig.8 Typical Transfer Characteristics

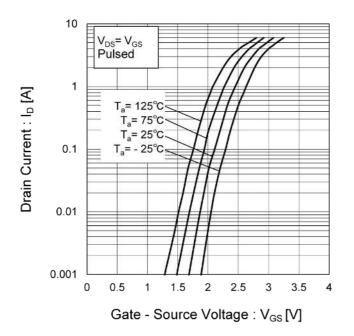


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

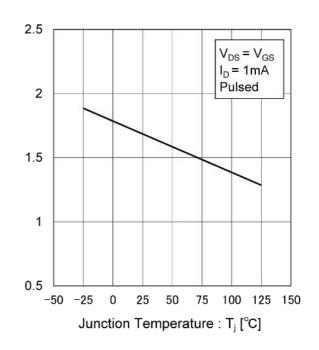
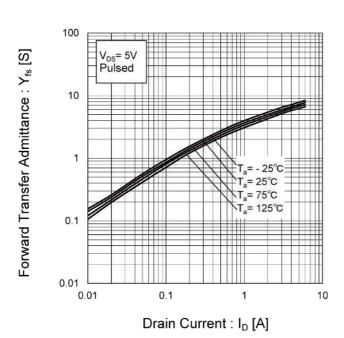


Fig.10 Forward Transfer Admittance vs.
Drain Current



Gate Threshold Voltage: V_{GS(th)} [V]

Fig.11 Drain Current Derating Curve

120 100 **Drain Current Dissipation** 80 : I_D/I_Dmax. [%] 60 40 20 0 -25 25 50 75 100 125 150 Junction Temperature : T_j [°C]

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

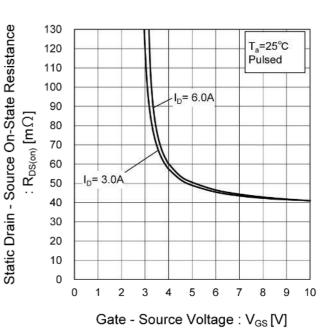


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

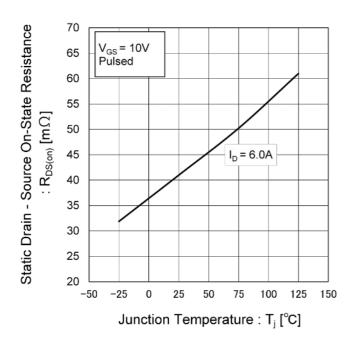


Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

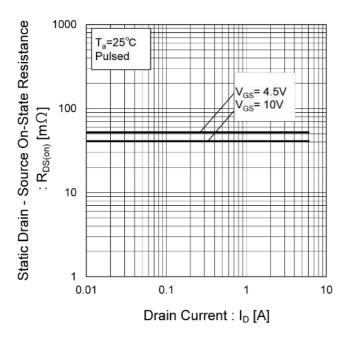


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

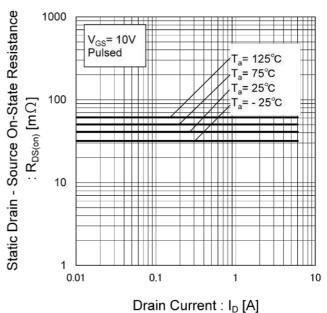


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

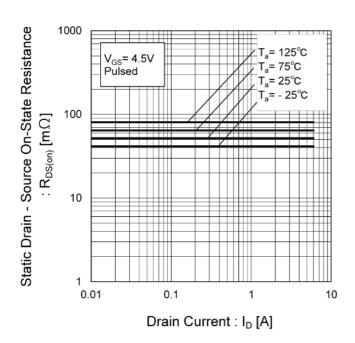


Fig.17 Typical Capacitances vs.

Drain - Source Voltage

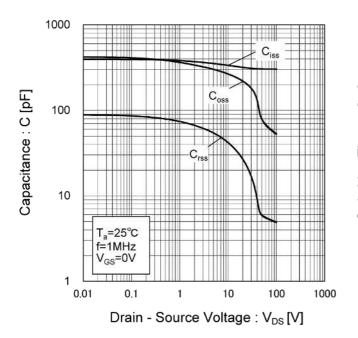


Fig.18 Switching Characteristics

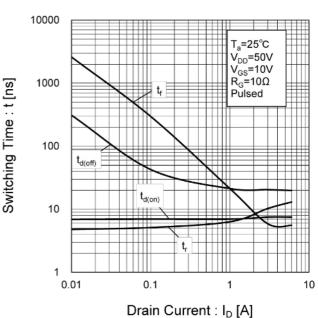


Fig.19 Typical Gate Charge

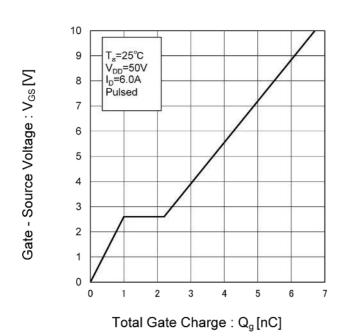
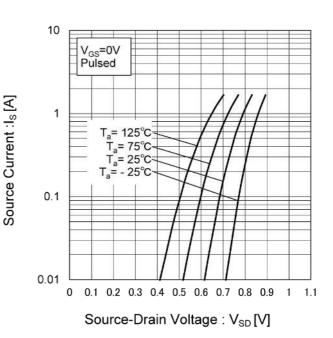


Fig.20 Source Current vs.

Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

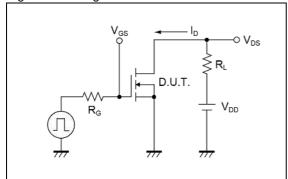


Fig.1-2 Switching Waveforms

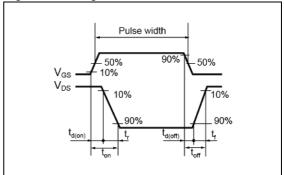


Fig.2-1 Gate Charge Measurement Circuit

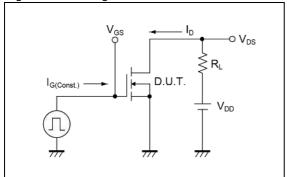


Fig.2-2 Gate Charge Waveform

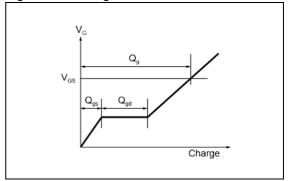


Fig.3-1 Avalanche Measurement Circuit

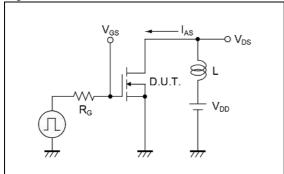
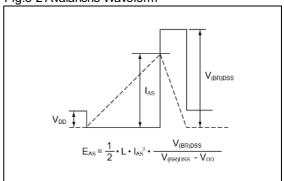


Fig.3-2 Avalanche Waveform

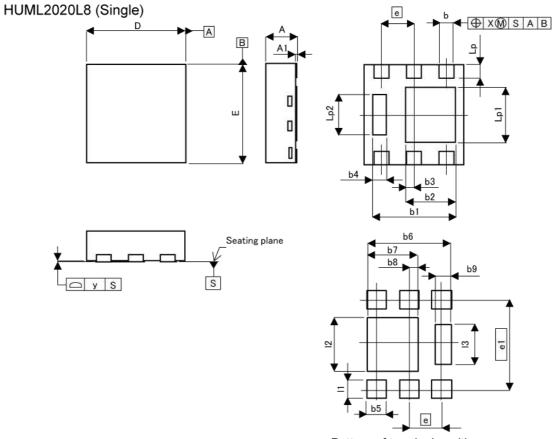


Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

Dimensions

DFN2020-8S



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM I	MILIME	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
Α	0.55	0.65	0.022	0.026
A1	0.00	0.05	0.000	0.002
b	0.25	0.35	0.010	0.014
b1	1.55	1.75	0.061	0.069
b2	0.95	1.05	0.037	0.041
b3	0.1	75	0.0	07
b4	0.	25	0.0	10
D	1.90	2.10	0.075	0.083
E	1.90	2.10	0.075	0.083
е	0.60	0.70	0.024	0.028
Lp	0.225	0.325	0.009	0.013
Lp1	1.00	1.20	0.039	0.047
Lp2	0.	80	0.0	31
x	2	0.10		0.004
У	(B)	0.10	3.53	0.004

DIM -	MILIM	MILIMETERS		HES
DIIVI	MIN	MAX	MIN	MAX
b5	3-67	0.45	3 = 3	0.018
b6		1.75	949	0.069
b7	-	1.05		0.041
b8	0.175		0.007	
b9	. .	0.30	3#8	0.012
e1	1.725		0.0	068
11		0.425	1074	0.017
12	3-67	1.15	3.79	0.045
13	(4)	0.85	34	0.033

Dimension in mm/inches



Notice

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CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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